

FS6M07652RTC

Fairchild Power Switch(FPS)

Features

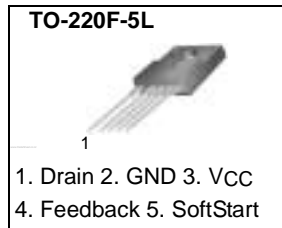
- Fixed Frequency
- Internal Burst Mode Controller for Stand-by Mode
- Pulse By Pulse Over Current Limiting
- Over Current Protection(Auto Restart Mode)
- Over Voltage Protection (Auto Restart Mode)
- Over Load Protection(Auto Restart Mode)
- Internal Thermal Shutdown Function(Latch Mode)
- Under Voltage Lockout
- Internal High Voltage Sense FET
- Soft Start

Application

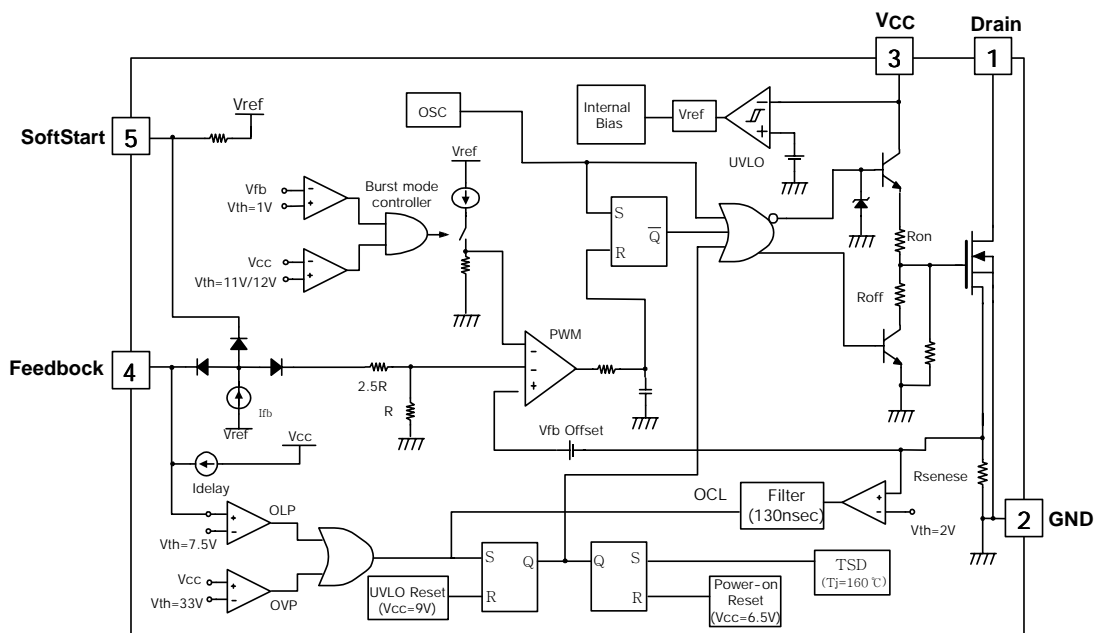
- LCD Monitor SMPS
- Adaptor

Description

The Fairchild Power Switch(FPS) product family is specially designed for an off line SMPS with minimal external components. The Fairchild Power Switch(FPS) consist of a high voltage power SenseFET and a current mode PWM IC. Included PWM controller features integrated fixed oscillator, the under voltage lock out, the leading edge blanking, the optimized gate turn-on/turn-off driver, the thermal shutdown protection, the over voltage protection, and the temperature compensated precision current sources for the loop compensation and a fault protection circuitry. compared with a discrete MOSFET and a controller or a RCC switching converter solution, a Fairchild Power Switch(FPS) can reduce total component count, design size, and weight and at the same time increase efficiency, productivity, and system reliability. It has a basic platform well suited for the cost effective LCD monitor power supply.



Internal Block Diagram



Absolute Maximum Ratings

(Ta=25°C, unless otherwise specified)

| Characteristic | Symbol | Value | Unit |
|-------------------------------------------------------------------------|--------------|-------------|-------|
| Drain-Gate Voltage (RGS=1MΩ) | VDGR | 650 | V |
| Gate-Source (GND) Voltage | VGS | ±30 | V |
| Drain Current Pulsed ⁽¹⁾ | IDM | 14.4 | ADC |
| Continuous Drain Current (Tc = 25°C) | ID | 3.6 | ADC |
| Continuous Drain Current (TC=100°C) | ID | 2.28 | ADC |
| Single Pulsed Avalanche Current ⁽³⁾ (Energy ⁽²⁾) | IAS(EAS) | 17(570) | A(mJ) |
| Maximum Supply Voltage | VCC, MAX | 35 | V |
| Input Voltage Range | VFB | -0.3 to VCC | V |
| | VSS | -0.3 to 10 | V |
| Total Power Dissipation | PD(Watt H/S) | 46 | W |
| | Darting | 0.37 | W/°C |
| Operating Junction Temperature | Tj | +150 | °C |
| Operating Ambient Temperature | TA | -25 to +85 | °C |
| Storage Temperature Range | TSTG | -55 to +150 | °C |

Notes:

1. Repetitive rating: Pulse width limited by maximum junction temperature
2. L=81mH, starting Tj=25°C
3. L=13uH, starting Tj=25°C

Electrical Characteristics (SFET part)

(Ta=25°C unless otherwise specified)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|--------------------------------------------------|---------|--------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| Drain-Source Breakdown Voltage | BVDSS | VGS=0V, ID=250μA | 650 | - | - | V |
| Zero Gate Voltage Drain Current | IDSS | VDS=650V, VGS=0V | - | - | 200 | μA |
| | | VDS=520V VGS=0V, TC=125°C | - | - | 300 | μA |
| Static Drain-Source On Resistance ⁽¹⁾ | RDS(ON) | VGS=10V, ID=1.8A | - | 1.3 | 1.6 | Ω |
| Forward Transconductance ⁽²⁾ | gfs | VDS=50V, ID=1.8A | - | 3.3 | - | S |
| Input Capacitance | Ciss | VGS=0V, VDS=25V, f = 1MHz | - | 1200 | - | pF |
| Output Capacitance | Coss | | - | 125 | - | |
| Reverse Transfer Capacitance | Crss | | - | 23 | - | |
| Turn On Delay Time | td(on) | VDD=325V, ID=6.5A (MOSFET switching time is essentially independent of operating temperature) | - | 22 | - | nS |
| Rise Time | tr | | - | 70 | - | |
| Turn Off Delay Time | td(off) | | - | 105 | - | |
| Fall Time | tf | | - | 65 | - | |
| Total Gate Charge (Gate-Source+Gate-Drain) | Qg | VGS=10V, ID=6.5A, VDS=520V (MOSFET switching time is essentially independent of operating temperature) | - | 40 | - | nC |
| Gate-Source Charge | Qgs | | - | 6.5 | - | |
| Gate-Drain (Miller) Charge | Qgd | | - | 18 | - | |

Note:

1. Pulse test : Pulse width ≤ 300μS, duty 2%

2. $S = \frac{1}{R}$

Electrical Characteristics (Continued)

(Ta=25°C unless otherwise specified)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|----------------------------------------------|----------|-----------------------|------|------|------|------|
| UVLO SECTION | | | | | | |
| Start Threshold Voltage | VSTART | VFB = GND | 14 | 15 | 16 | V |
| Stop Threshold Voltage | VSTOP | VFB = GND | 8 | 9 | 10 | V |
| OSCILLATOR SECTION | | | | | | |
| Initial Frequency | FOSC | - | 63 | 70 | 77 | kHz |
| Voltage Stability | FSTABLE | 12V ≤ VCC ≤ 23V | 0 | 1 | 3 | % |
| Temperature Stability (2) | ΔFOSC | -25°C ≤ Ta ≤ 85°C | 0 | ±5 | ±10 | % |
| Maximum Duty Cycle | DMAX | - | 75 | 80 | 85 | % |
| Minimum Duty Cycle | DMIN | - | - | - | 0 | % |
| FEEDBACK SECTION | | | | | | |
| Feedback Source Current | IFB | VFB = GND | 0.7 | 0.9 | 1.1 | mA |
| Shutdown Feedback Voltage | VSD | VFB ≥ 6.9V | 6.9 | 7.5 | 8.1 | V |
| Shutdown Delay Current | IDELAY | VFB = 5V | 3.2 | 4.0 | 4.8 | μA |
| SOFTSTART SECTION | | | | | | |
| Softstart Voltage | VSS | VFB = 2 | 4.7 | 5.0 | 5.3 | V |
| Softstart Current | ISS | VSS = V | 0.8 | 1.0 | 1.2 | mA |
| BURST MODE SECTION | | | | | | |
| Burst Mode Low Threshold Voltage | VBURL | VFB = 0V | 10.4 | 11.0 | 11.6 | V |
| Burst Mode High Threshold Voltage | VBURH | VFB = 0V | 11.4 | 12.0 | 12.6 | V |
| Burst Mode Enable Feedback Voltage | VBEN | VCC = 10.5V | 0.7 | 1.0 | 1.3 | V |
| Burst Mode Peak Current Limit (4) | IBURPK | VCC = 10.5V, VFB = 0V | 0.38 | 0.5 | 0.62 | A |
| Burst Mode Frequency | FBUR | VCC = 10.5V, VFB = 0V | 63 | 70 | 77 | kHz |
| CURRENT LIMIT(SELF-PROTECTION)SECTION | | | | | | |
| Peak Current Limit (4) | IOVER | - | 1.76 | 2.0 | 2.24 | A |
| PROTECTION SECTION | | | | | | |
| Over Voltage Protection | VOVP | VCC ≥ 29V | 29 | 33 | 37 | V |
| Over Current Latch Voltage (3) | VOCL | - | 1.8 | 2.0 | 2.2 | V |
| Thermal Shutdown Temp (2) | TSD | - | 140 | 160 | - | °C |
| TOTAL DEVICE SECTION | | | | | | |
| Start Up Current | ISTART | VFB = GND, VCC = 14V | - | 0.1 | 0.17 | mA |
| Operating Supply Current (1) | IOP | VFB = GND, VCC = 16V | - | 10 | 15 | mA |
| | IOP(MIN) | VFB = GND, VCC = 12V | | | | |
| | IOP(MAX) | VFB = GND, VCC = 30V | | | | |

Notes:

1. These parameters are the current flowing in the control IC.
2. These parameters, although guaranteed at the design, are not 100% tested in production.
3. These parameters, although guaranteed, are tested in EDS(wafer test) process.
4. These parameters indicate inductor current.

Typical Performance Characteristics

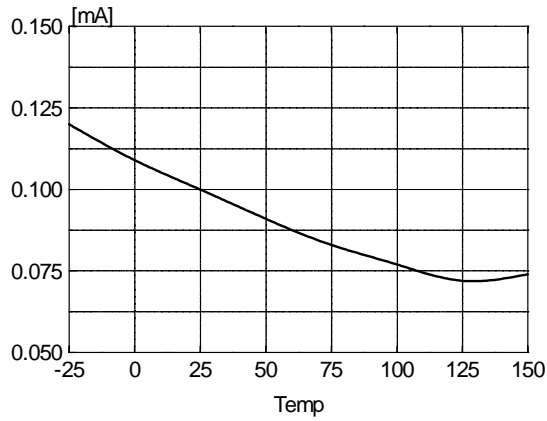


Figure 1. Start Up Current vs. Temp

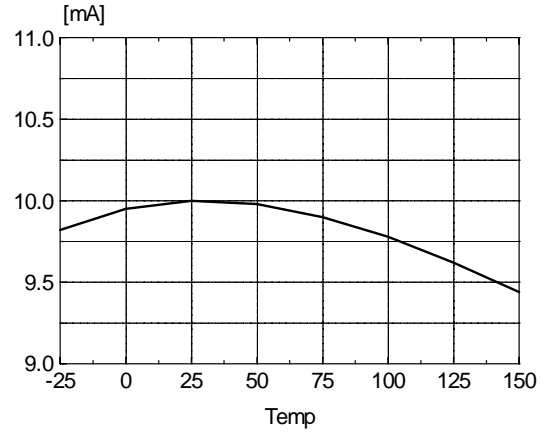


Figure 2. Operating Current vs. Temp

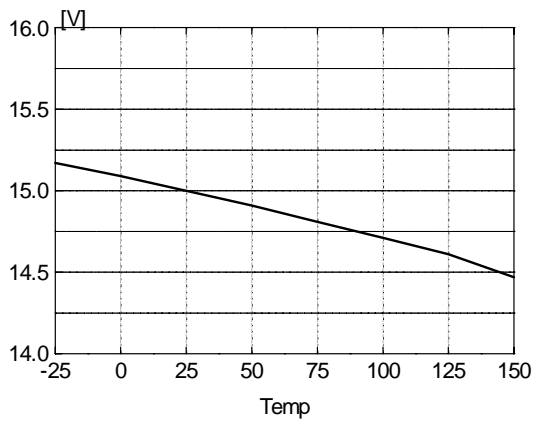


Figure 3. Start Threshold Voltage vs. Temp

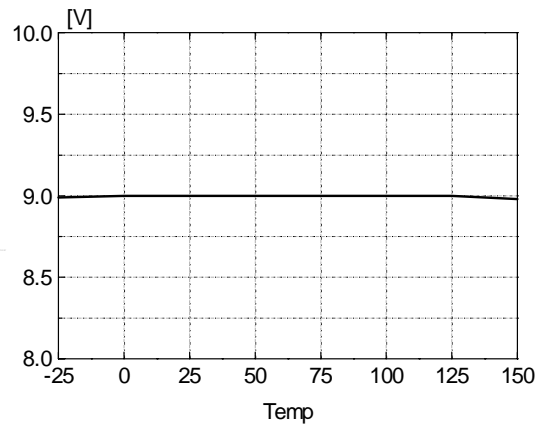


Figure 4. Stop Threshold Voltage vs. Temp

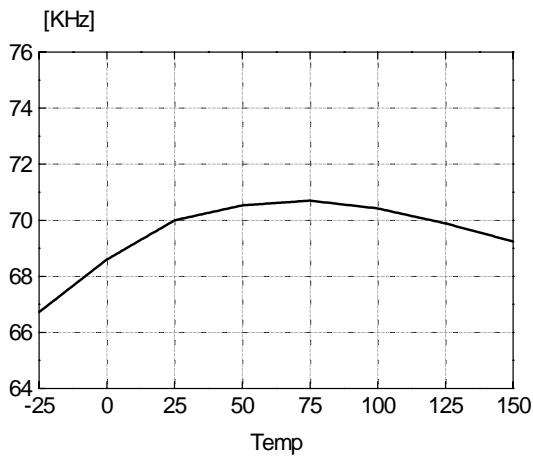


Figure 5. Initial Frequency vs. Temp

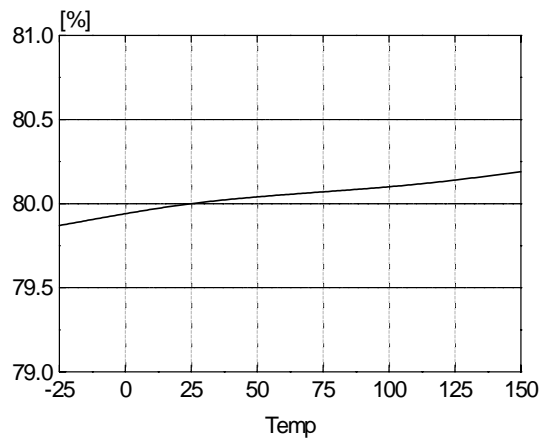


Figure 6. Maximum Duty vs. Temp

Typical Performance Characteristics (Continued)

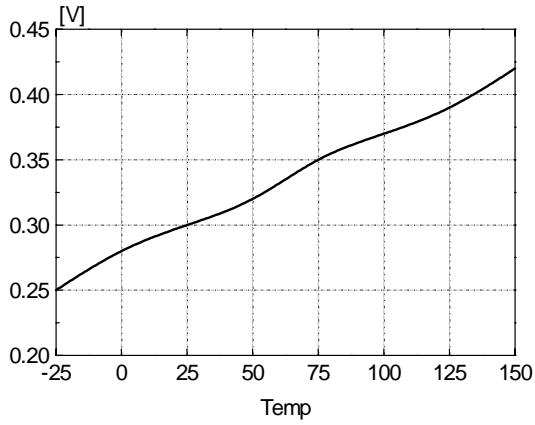


Figure 7. Feedback Offset Voltage vs. Temp

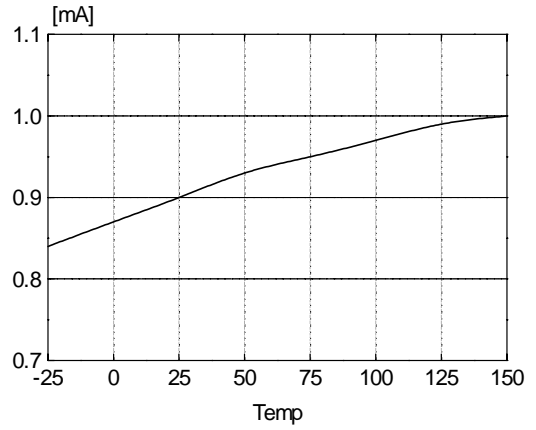


Figure 8. Feedback Source Current vs. Temp

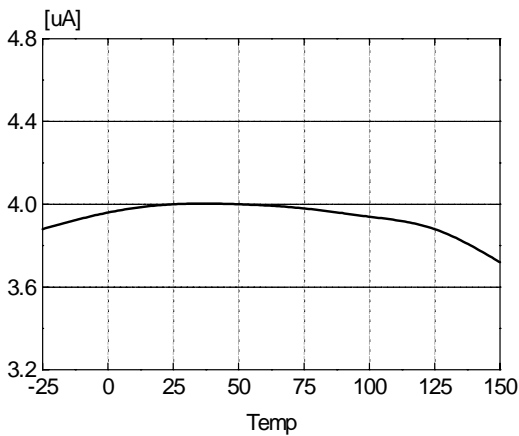


Figure 9. ShutDown Delay Current vs. Temp

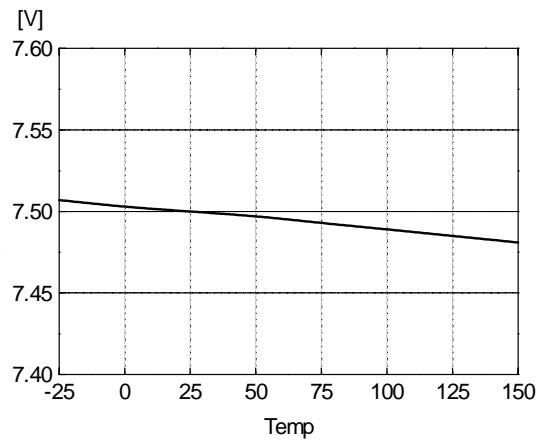


Figure 10. ShutDown Feedback Voltage vs. Temp

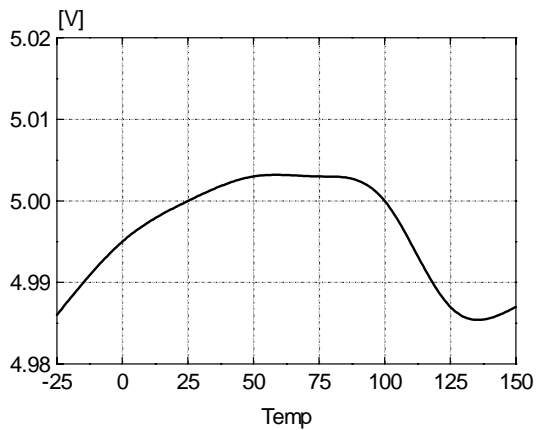


Figure 11. Softstart Voltage vs. Temp

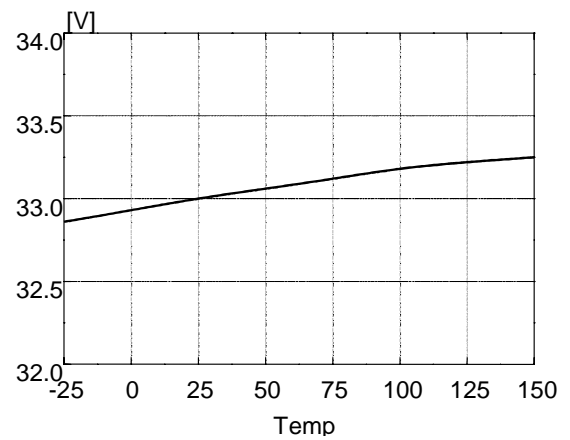


Figure 12. Over Voltage Protection vs. Temp

Typical Performance Characteristics (Continued)

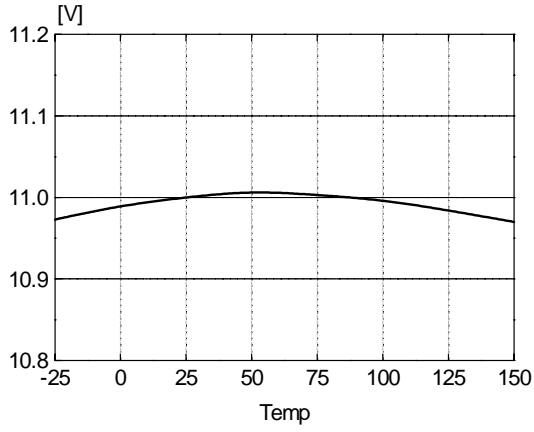


Figure 13. Burst Mode Low Voltage vs. Temp

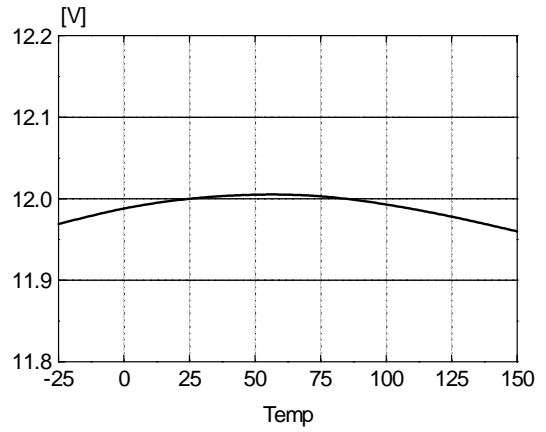


Figure 14. Burst Mode High Voltage vs. Temp

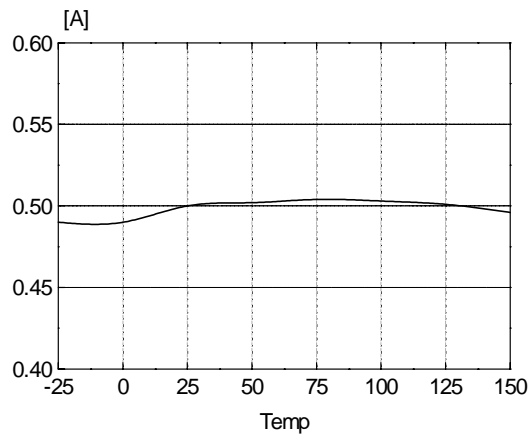


Figure 15. Burst Mode Peak Current vs. Temp

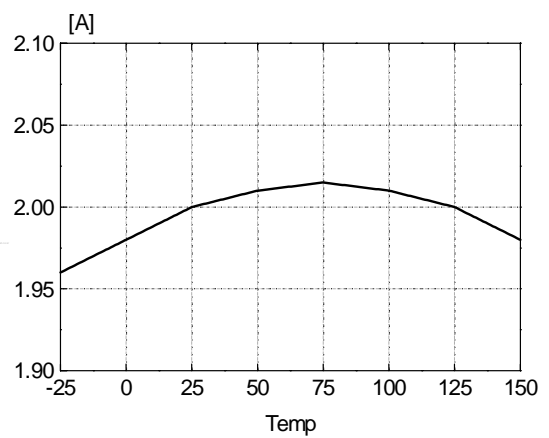
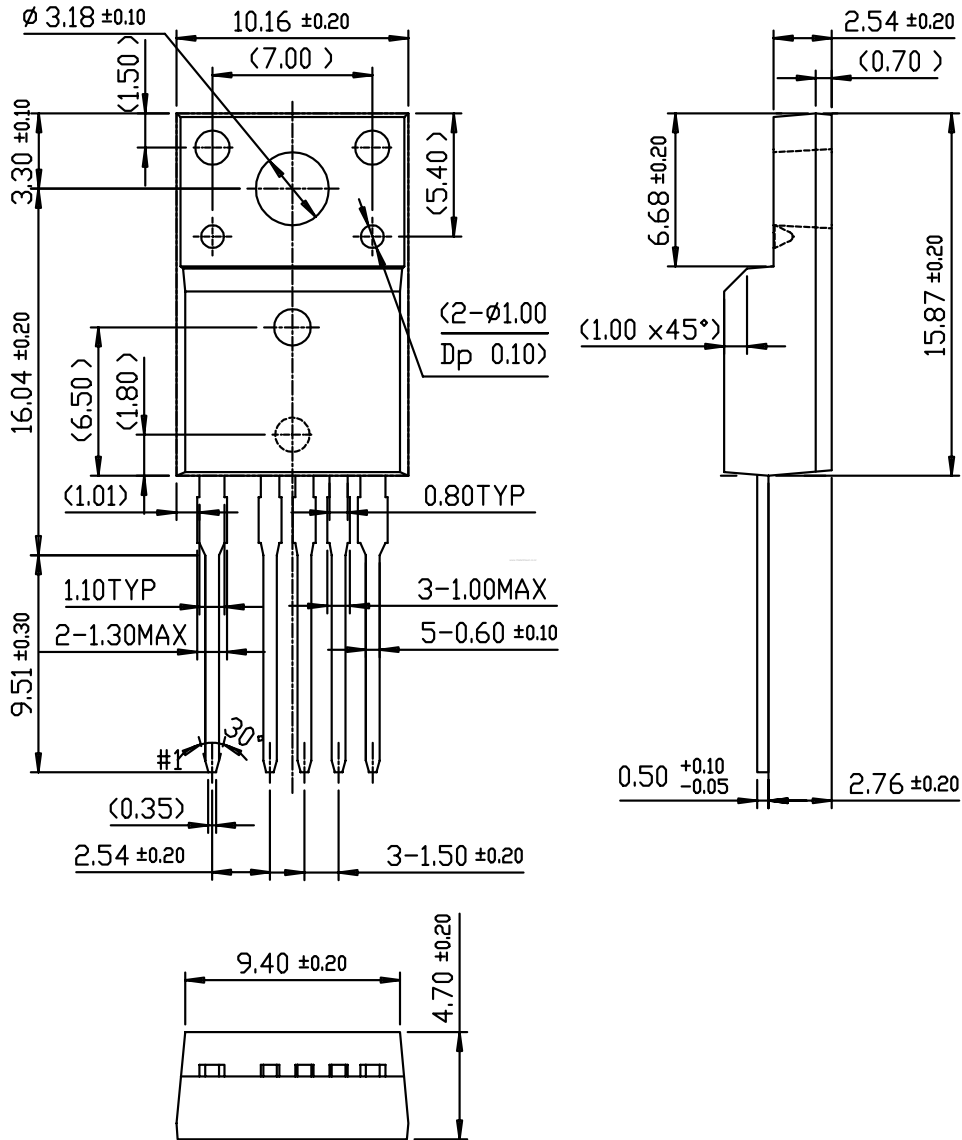


Figure 16. Over Current Limit vs. Temp

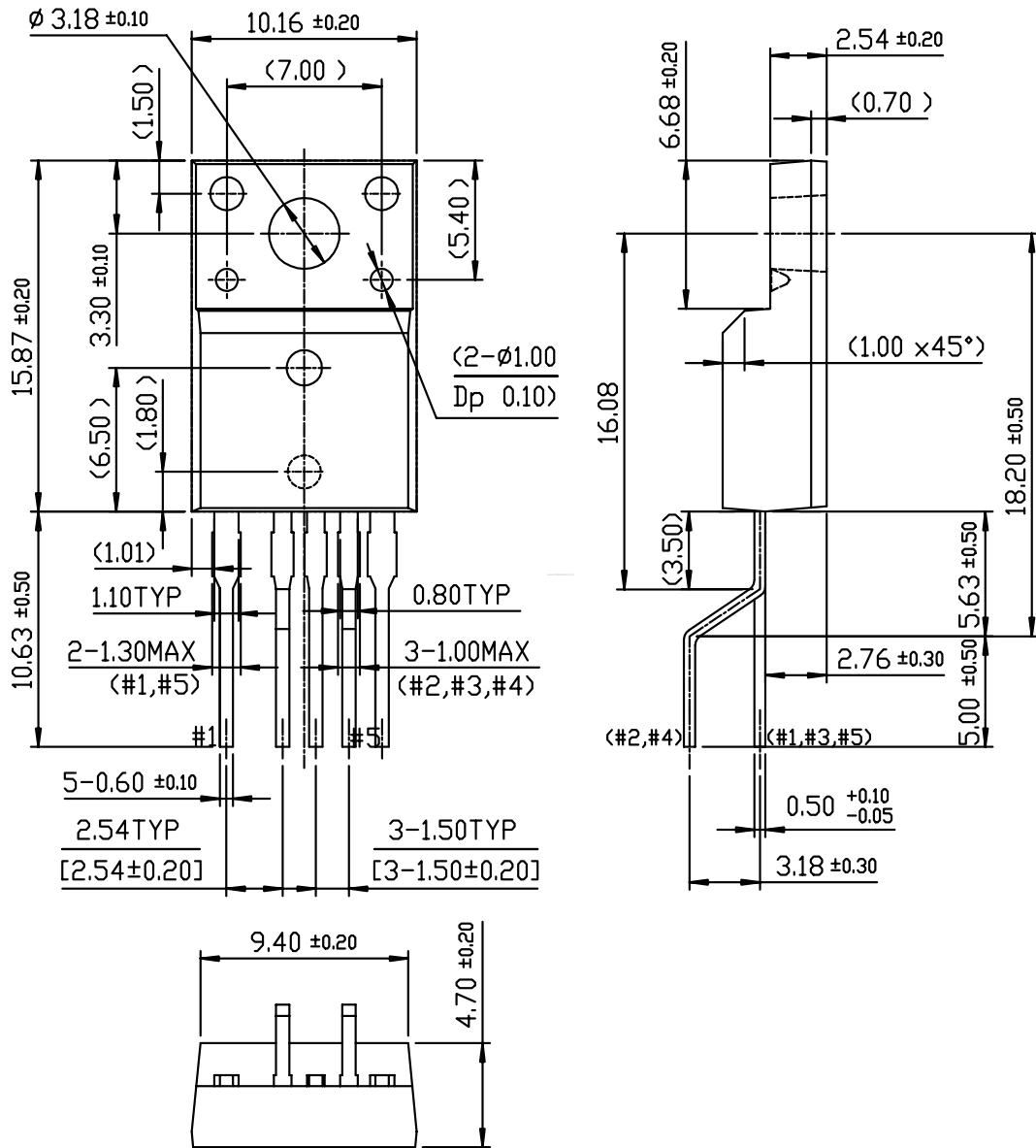
Package Dimensions

TO-220F-5L



Package Dimensions (Continued)

TO-220F-5L(Forming)



Ordering Information

| Product Number | Package | Marking Code | BVdss | Rds(on) |
|-----------------|---------------------|---------------|-------|---------|
| FS6M07652RTCTU | TO-220F-5L | 6M07652R C | 650V | 1.6 |
| FS6M07652RTCYDT | TO-220F-5L(Forming) | | | |

TU : Non Forming Type

YDT : Forming Type

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